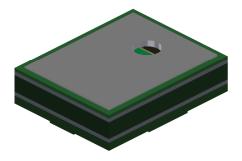
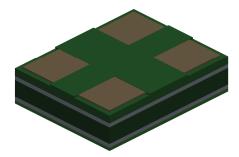


"Mini" SiSonic™ Microphone Specification - *Halogen Free*





Knowles Acoustics 1151 Maplewood Drive Itasca, IL 60143





1. DESCRIPTION AND APPLICATION

1.1 DESCRIPTION

"Mini" Surface Mount Silicon Microphone

1.2 APPLICATION

Hand held telecomunication devices.

2. PART MARKING

Identification Number Convention

S 1 2 3

4 5 6 7

S: Manufacturing Location
"S" - Knowles Electronics Suzhou Suzhou, China

> "No Alpha Character" - Knowles Electronics Itasca, IL USA

"E" - Engineering Samples

Digits 1-7: Job Identification Number

3. TEMPERATURE RANGE

3.1 Operating Temperature Range: -40°C to +100°C

3.2 Storage Temperature Range: -40°C to +100°C





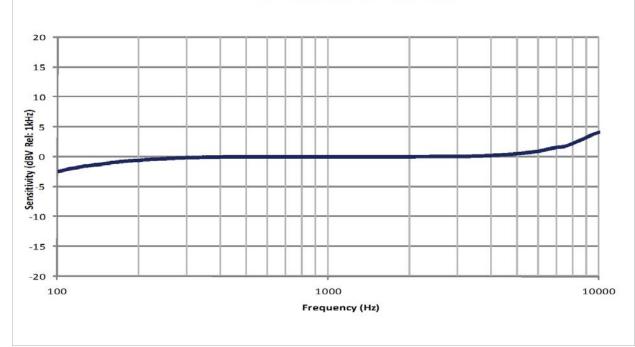
4. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: +20°C, 60-70% R.H.

	Symbol	Condition	Limits		Unit	
	Syrribor	Condition	Min.	Nom.	Max.	Offili
Directivity		Omni-directional				
Sensitivity	S	@ 1kHz (0dB-1V/Pa)	-45	-42	-39	dB
Output Impedance	Zout	@ 1kHz (0dB-1V/Pa)			300	Ω
Current Consumption	IDDS	Across 1.5 to 3.6 volts			250	μA
Signal to Noise Ratio	S/N	@ 1kHz (0dB-1V/Pa)		59		dB
Supply Voltage	Vs		1.5		3.6	V
Sensitivity Loss Across		Change in sensitivity	No Char	ige Across	: Voltage	dB
Voltage		over 3.6V to 1.5V		Range		аь
Maximum Input Sound		At 100dB	SPL, THD <	< 1%		
Level		At 115dB \$	SPL, THD <u>≤</u> 10%			

5. FREQUENCY RESPONSE CURVE

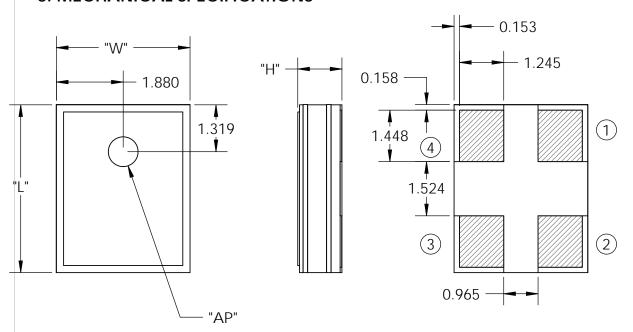
TYPICAL FREE FIELD RESPONSE NORMALIZED TO 1kHz







6. MECHANICAL SPECIFICATIONS



ITEM	DIMENSION	TOLERANCE	UNITS
LENGTH (L)	4.720	±0.100	mm
WIDTH (W)	3.760	±0.100	mm
HEIGHT (H)	1.250	±0.100	mm
ACOUSTIC PORT (AP)	Ø0.838	±0.100	mm

	PIN OUTPUT
PIN #	FUNCTION
1	OUTPUT
2	GROUND
3	GROUND
4	POWER (Vdd)

Note:

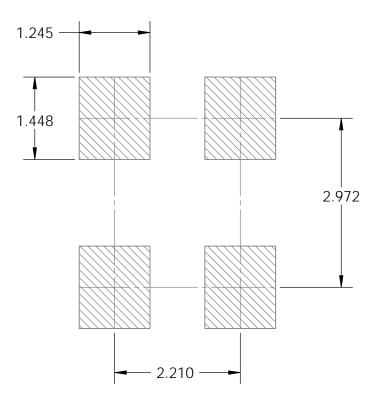
 $\label{lem:decomposition} \mbox{ Dimensions are in milimeters unless otherwise specified.}$

Tolerance ± 0.15 mm unless otherwise specified.





7. RECOMMENDED CUSTOMER LAND PATTERN



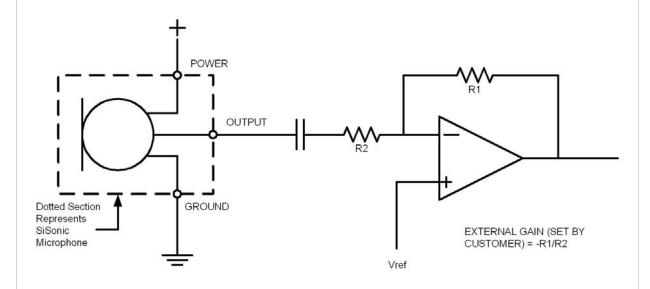
8. RECOMMENDED SOLDER STENCIL PATTERN

N/A





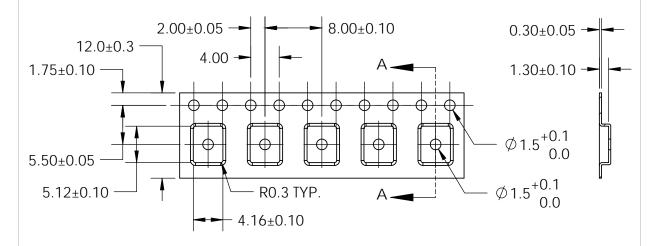
9. RECOMMENDED INTERFACE CIRCUIT

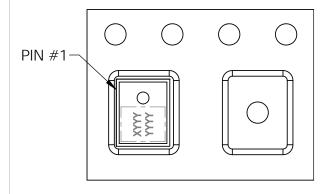






10. PACKAGING DETAIL





COMPONENT ORIENTATION

MODEL NUMBER	SUFFIX	REEL DIAMETER	QUANTITY PER REEL
SPM0404HD5H-PB	-2	7"	1,200
31 MO404HD3H-FB	-6	13"	4,800

TAPE & REEL	PER EIA-481
LABEL	LABEL APPLIED TO EXTERNAL PACKAGE &
LANDEL	DIRECT TO REEL.

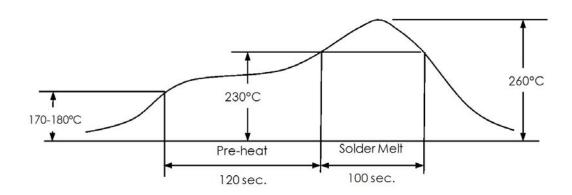
Note:

Dimensions are in milimeters unless otherwise specified.





11. SOLDER FLOW PROFILE



Stage	Temperature Profile	Time (maximim)
Pre-heat	170 ~ 180°C	120 sec.
Solder Melt	Above 230°C	100 sec.
Peak	260°C maximum	30 sec.

12. ADDITIONAL NOTES

- Shelf life: Twelve (12) months when devices are to be stored in factory supplied, unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H. MSL (moisture sensitivity level) Class 2a.

 <u>Do not pull a vacuum</u> over port hole of the microphone. Pulling a vacum over the (A)
- (B) port hole can damage the device.
- Do not board wash after the reflow process. Board washing and cleaning agents can damage the device. Do not expose to ultrasonic processing or cleaning.

 Do not brush board after the reflow process. Brushing the board with/without (C)
- (D) solvents can damage the device.
- (E) Do not insert any object in port hole of device at any time as this can damage the
- (F) Number of reflow - Recommend no more than 3 cycles.



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13. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

Test	Description
Thermal Shock	100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks. (ICE 68-2-4)
High Temperature Storage	+105°C environment for 1,000 hours. (ICE 68-2-2 Test Ba)
Low Temperature Storage	-40°C environment for 1,000 hours. (ICE 68-2-2 Test Aa)
High Temperature Bias	+105°C environment while under bias for 1,000 hours. (ICE 68-2-2 Test Ba)
Low Temperature Bias	-40°C environment while under bias for 1,000 hours. (ICE 68-2-2 Test Aa)
Temperature / Humidity Bias	+85°C/85% R.H. environment while under bias for 1,000 hours. (JESD22-A101A-B)
Vibration	4 cycles lasting 12 minutes from 20 TO 2,000 Hz in X, Y and Z direction with peak acceleration of 20g. (MIL 883E, Method 2007.2, A)
Electrostatic Discharge	3 discharges at +/-8kV direct contact to lid when unit is grounded (IEC 61000-4-2) and 3 discharges at +/-2kV direct contact to I/O pins. (MIL 883E, Method 3015.7)
Reflow	5 reflow cycles with peak temperature of +260°C.
Mechanical Shock	3 pulses of 10,000g in the X, Y and Z direction. (IEC 68-2-27, Test Ea)





14. SPECIFICATION REVISIONS

Revision	Detailed Specification Changes	Date
Α	Specification Release. (DMS)	8/14/2009

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